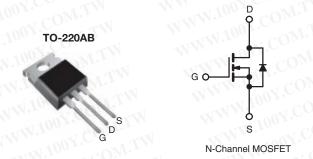


勝 特 力 材 料 886-3-5753170 胜特力电子(上海) 86-21-34970699 胜特力电子(深圳) 86-755-83298787 Http://www.100y.com.tw

Power MOSFET

PRODUCT SUMI	MARY	VI.
V _{DS} (V)	60	Mil
R _{DS(on)} (Ω)	V _{GS} = 10 V	0.028
Q _g (Max.) (nC)	67	TY
Q _{gs} (nC)	18	CO_{Mr}
Q _{gd} (nC)	25	COM.
Configuration	Singl	е



FEATURES

- Dynamic dV/dt Rating
- 175 °C Operating Temperature
- Fast Switching
- Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC



DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universially preferred for commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION	"TON'COM" TW WWW. TON'COM
Package	TO-220AB
Load (Db) from	IRFZ44PbF
Lead (Pb)-free	SiHFZ44-E3
CarDb (VI)	IRFZ44
SnPb	SiHFZ44

ABSOLUTE MAXIMUM RATINGS (T_{C}	= 25 °C, unl	ess otherwis	e noted)		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V _{DS}	60	V	
Gate-Source Voltage		V_{GS}	± 20	COMA	
Continuous Drain Current ^e	\/ at 10 \/	T _C = 25 °C	OMITW	50	MOD
Continuous Drain Current	uous Drain Current V_{GS} at 10 V $T_C = 100 ^{\circ}$ C		D	36	Α
Pulsed Drain Current ^a	W	WW.	I _{DM}	200	M.CO
Linear Derating Factor		COM	1.0	W/°C	
Single Pulse Avalanche Energy ^b		E _{AS}	100	mJ	
Maximum Power Dissipation T _C = 25 °C		P _D	150	W	
Peak Diode Recovery dV/dt ^c		dV/dt	4.5	V/ns	
erating Junction and Storage Temperature Range T _J , T _{stg} - 55 to + 17		- 55 to + 175	V 10°C		
Soldering Recommendations (Peak Temperature)d	for	10 s	ON COL	300	1007
Martin T. CO	0.00 1	40	· rand CO	10	lbf ⋅ in
Mounting Torque	6-32 or M3 screw		N.100 1. CO	1.1	N·m

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11). WW.100Y.COM.TW
- b. V_{DD} = 25 V, starting T_J = 25 °C, L = 44 μ H, R_g = 25 Ω , I_{AS} = 51 A (see fig. 12).
- c. $I_{SD} \le 51$ A, $dI/dt \le 250$ A/µs, $V_{DD} \le V_{DS}$, $T_J \le 175$ °C.
- d. 1.6 mm from case.
- e. Current limited by the package, (die current = 51 A).

^{*} Pb containing terminations are not RoHS compliant, exemptions may apply



		100		VISHAT®
Vishay Siliconix				
				•
THERMAL RESISTANCE RAT	rings	MMM.	Y.COM.	
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R _{thJA}	- W.11	62	
Case-to-Sink, Flat, Greased Surface	R _{thCS}	0.50	TON JAN	°C/W
Maximum Junction-to-Case (Drain)	R _{thJC}	-1/1/1/1	1.0	

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static	1007.CO	WILL	WW. 100X.C.	WI.IV			
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 250 μA	60	N -	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 1 mA	Olin.	0.060	-	V/°C
Gate-Source Threshold Voltage	$V_{GS(th)}$	V _{DS} =	· V _{GS} , I _D = 250 μA	2.0	. · <u>-</u>	4.0	V
Gate-Source Leakage	I _{GSS}		$V_{GS} = \pm 20 \text{ V}$	LOM	1.15	± 100	nA
Zero Gate Voltage Drain Current	I _{DSS}		= 60 V, V _{GS} = 0 V V _{GS} = 0 V, T _J = 125 °C	V GOD		25 250	μΑ
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 31 A ^b		$Mr_{T_{\mu}}$	0.028	Ω
Forward Transconductance	9 _{fs}	V _{DS}	= 25 V, I _D = 31 A	15	W.T.	-	S
Dynamic	MALA	UNY.CO	LA MALL	nov.C	~NIJ	W	•
Input Capacitance	C _{iss}	COM	$V_{GS} = 0 V$,	. No.	1900	TV	
Output Capacitance	C _{oss}	COM	$V_{DS} = 25 \text{ V},$	Jan	920	TI	pF
Reverse Transfer Capacitance	C _{rss}	f = 1.	0 MHz, see fig. 5	N. 100.	170	-XXI	
Total Gate Charge	Qg	W.1007.	W.TW	W.100	-1 CO	67	ī
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V	$I_D = 51 \text{ A}, V_{DS} = 48 \text{ V},$ see fig. 6 and 13^b	NV-10	7 C(18	nC
Gate-Drain Charge	Q_{gd}	1007.0	OMITW	- 1 N.1	10 x.	25	NN
Turn-On Delay Time	t _{d(on)}	100X	-OM.TW	TAN	14	No.	LAA
Rise Time	t _r	V _{DD} =	= 30 V, I _D = 51 A,	MAI	110	-	TW
Turn-Off Delay Time	t _{d(off)}	$R_g = 9.1 \Omega$,	$R_D = 0.55 \Omega$, see fig. 10^b	WENN	45	Co	ns
Fall Time	t _f	MW.100	ON COM.	WW	92	V.EO	VI
Internal Drain Inductance	L_D	Between lead, 6 mm (0.25") from package and center of die contact		-117	4.5	OX-CC	OnH
Internal Source Inductance	Ls			- 1	7.5	007.0	
Drain-Source Body Diode Characteristic	s		A.Too. COM.		WWw	Too	CO
Continuous Source-Drain Diode Current	o Is	MOSFET symbol showing the		-	WW	50	y.C ^C
Pulsed Diode Forward Current ^a	I _{SM}	integral revers p - n junction		N -	WV	200	01.C
Body Diode Voltage	V_{SD}	T _J = 25 °C	$I_{S} = 51 \text{ A}, V_{GS} = 0 \text{ V}^{b}$	W -	-11	2.5	OON.
Body Diode Reverse Recovery Time	Ct _{rr}	T 05 %0 1	E1 A al/at 100 A/:	TV	120 🦪	180	ns
Body Diode Reverse Recovery Charge	Q _{rr}	- I _J = 25 °C, I	$_{F}$ = 51 A, dl/dt = 100 A/ μ s	w.TN	0.53	0.80	nC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-		on is dor	ninated b	v I e and	12)

Notes

- WWW.100Y.COM.TW a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11). WWW.100Y.COM.TW
- b. Pulse width $\leq 300 \ \mu s$; duty cycle $\leq 2 \ \%$.



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

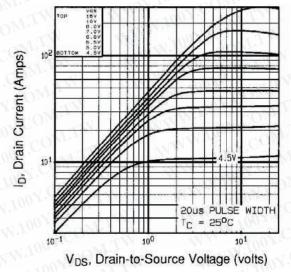


Fig. 1 Typical Output Characteristics, T_C = 25 °C

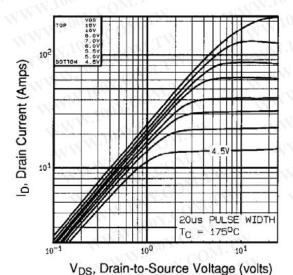


Fig. 2 - Typical Output Characteristics, T_C = 175 °C

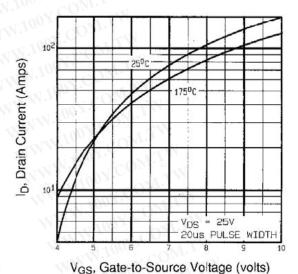


Fig. 3 - Typical Transfer Characteristics

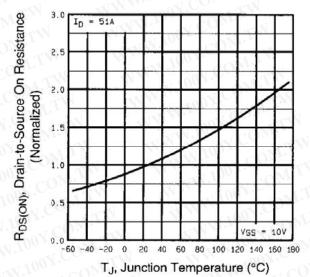


Fig. 4 - Normalized On-Resistance vs. Temperature



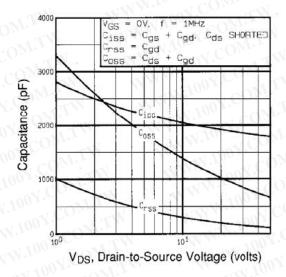


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

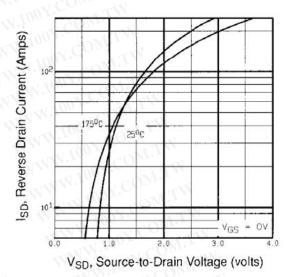


Fig. 7 - Typical Source-Drain Diode Forward Voltage

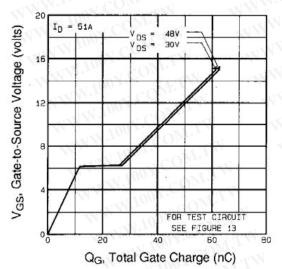


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

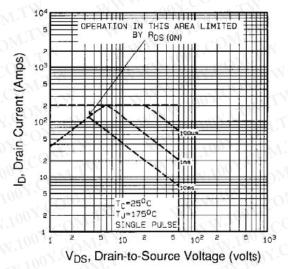


Fig. 8 - Maximum Safe Operating Area





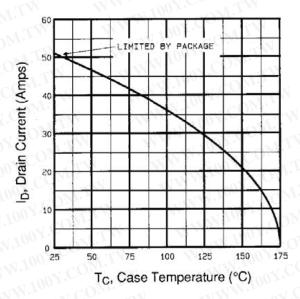


Fig. 9 - Maximum Drain Current vs. Case Temperature

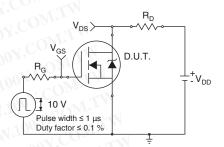


Fig. 10a - Switching Time Test Circuit

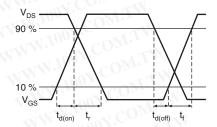


Fig. 10b - Switching Time Waveforms

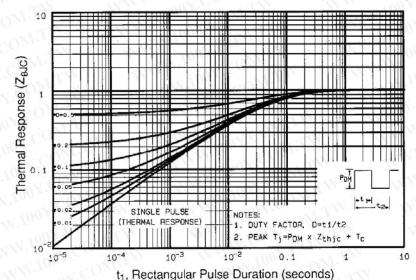


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

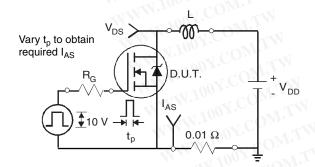


Fig. 12a - Unclamped Inductive Test Circuit

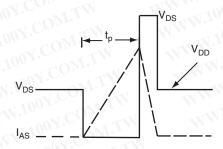
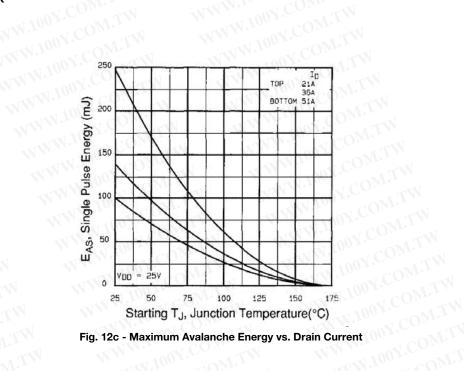


Fig. 12b - Unclamped Inductive Waveforms





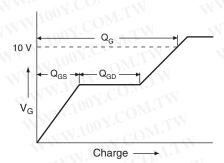


Fig. 13a - Basic Gate Charge Waveform

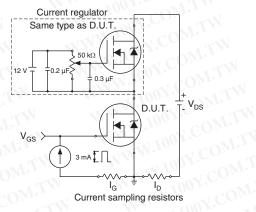
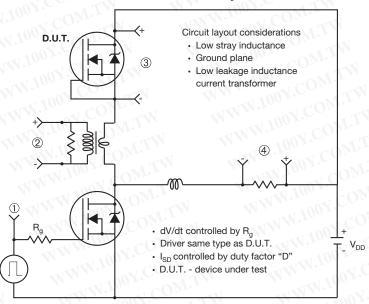


Fig. 13b - Gate Charge Test





Peak Diode Recovery dV/dt Test Circuit



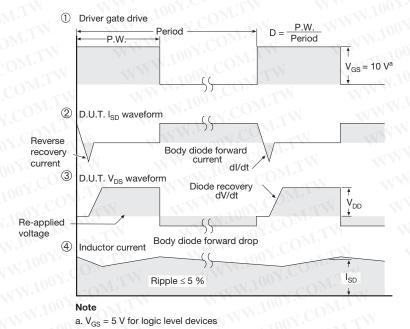
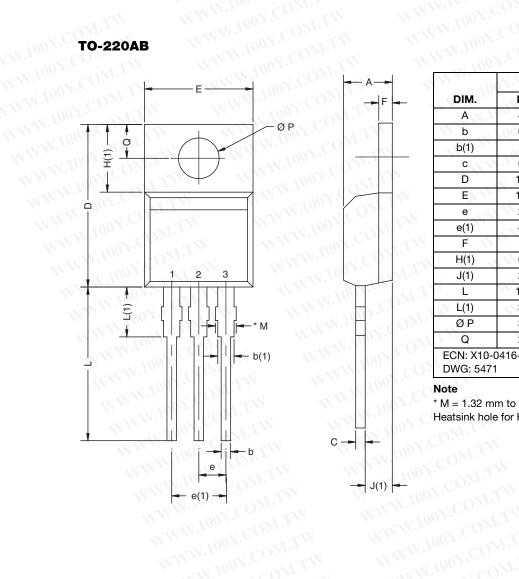


Fig. 14 - For N-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?91291.



TO-220AB



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M. 44.700	MILLIN	METERS	INCHES		
DIM.	MIN.	MAX.	MIN.	MAX	
A	4.25	4.65	0.167	0.18	
b	0.69	1.01	0.027	0.04	
b(1)	1.20	1.73	0.047	0.068	
С	0.36	0.61	0.014	0.024	
D	14.85	15.49	0.585	0.610	
ENV	10.04	10.51	0.395	0.414	
е	2.41	2.67	0.095	0.10	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.05	
H(1)	6.09	6.48	0.240	0.25	
J(1)	2.41	2.92	0.095	0.11	
L	13.35	14.02	0.526	0.552	
(1)	3.32	3.82	0.131	0.150	
ØР	3.54	3.94	0.139	0.15	
Q	2.60	3.00	0.102	0.118	

DWG: 5471

Note

TW.100Y.COM.TW

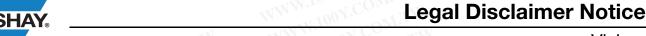
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WWW.100X

* M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM





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